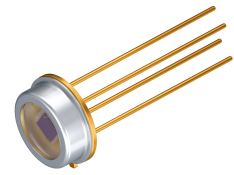


Silicon Dual Photodiode

Version 1.4

SFH 221



Features:

- Especially suitable for applications from 400 nm to 1100 nm
- High photosensitivity
- Hermetically sealed metal package (similar to TO-5), suitable up to 125 °C
- Double diode with extremely high homogeneousness

Applications

- Industrial electronics
- For control and drive circuits
- Edge drives
- Follow-up control

Ordering Information

Type:	Ordering Code
SFH 221	Q62702P0270

Note: For operating conditions of $T_A > 85\text{ °C}$ please contact us.

Maximum Ratings ($T_A = 25\text{ °C}$)

Parameter	Symbol	Values	Unit
Operating and storage temperature range	$T_{op}; T_{stg}$	-40 ... 125	°C
Reverse voltage	V_R	10	V
Insulation voltage vs. package	V_{IS}	100	V
Total Power dissipation	P_{tot}	50	mW
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	V_{ESD}	2000	V

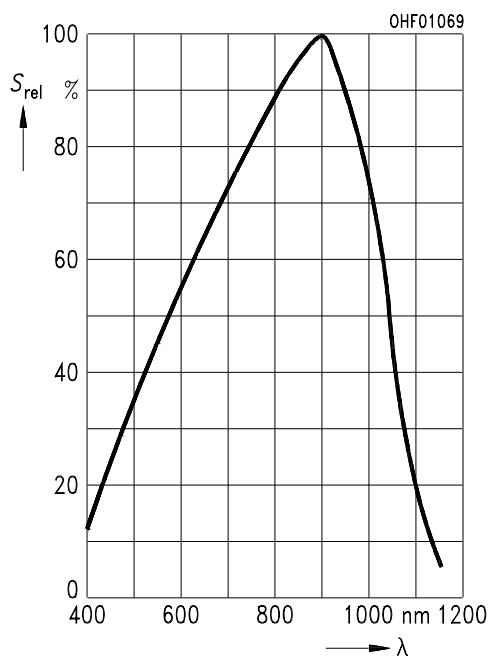
Characteristics ($T_A = 25\text{ °C}$, per single diode)

Parameter	Symbol	Values	Unit
Spectral sensitivity ($V_R = 5\text{ V}$, standard light A, $T = 2856\text{ K}$)	(typ) S	24 (≥ 15)	nA/lx
Wavelength of max. sensitivity	(typ) $\lambda_{S\max}$	900	nm
Spectral range of sensitivity	(typ) $\lambda_{10\%}$	(typ) 400 ... 1100	nm
Radiant sensitive area	(typ) A	1.54	mm ²
Dimensions of radiant sensitive area	(typ) L x W	0.7 x 2.2	mm x mm
Half angle	(typ) φ	± 55	°
Dark current ($V_R = 10\text{ V}$)	(typ (max)) I_R	10 (≤ 100)	nA
Spectral sensitivity of the chip ($\lambda = 850\text{ nm}$)	(typ) $S_{\lambda\text{ typ}}$	0.55	A / W
Max. deviation from average for each single diode	(typ) ΔS	± 5	%
Quantum yield of the chip ($\lambda = 850\text{ nm}$)	(typ) η	0.80	Electrons / Photon
Open-circuit voltage ($E_v = 1000\text{ lx}$, Std. Light A)	(typ (min)) V_O	330 (≥ 280)	mV
Short-circuit current ($E_v = 1000\text{ lx}$, Std. Light A)	(typ) I_{SC}	24	μA
Insulation current ($V_{IS} = 100\text{ V}$)	(typ (max)) I_{IS}	0.1 (≤ 1)	nA
Rise and fall time ($V_R = 5\text{ V}$, $R_L = 1\text{ k}\Omega$, $\lambda = 850\text{ nm}$)	(typ) t_r, t_f	0.5	μs
Forward voltage ($I_F = 40\text{ mA}$, $E = 0$)	(typ) V_F	1	V

Parameter		Symbol	Values	Unit
Capacitance ($V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$, $E = 0$)	(typ)	C_0	25	pF
Temperature coefficient of V_O	(typ)	TC_V	-2.6	mV / K
Temperature coefficient of I_{SC} (Std. Light A)	(typ)	TC_I	0.18	% / K
Noise equivalent power ($V_R = 10 \text{ V}$, $\lambda = 850 \text{ nm}$)	(typ)	NEP	0.103	pW / $\text{Hz}^{1/2}$
Detection limit ($V_R = 10 \text{ V}$, $\lambda = 850 \text{ nm}$)	(typ)	D^*	1.2e12	$\text{cm} \times \text{Hz}^{1/2} / \text{W}$

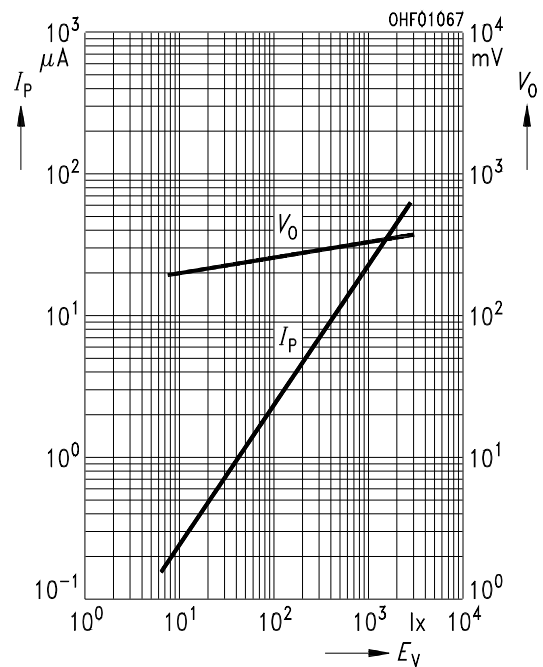
Relative Spectral Sensitivity ^{1) page 7}

$$S_{\text{rel}} = f(\lambda)$$



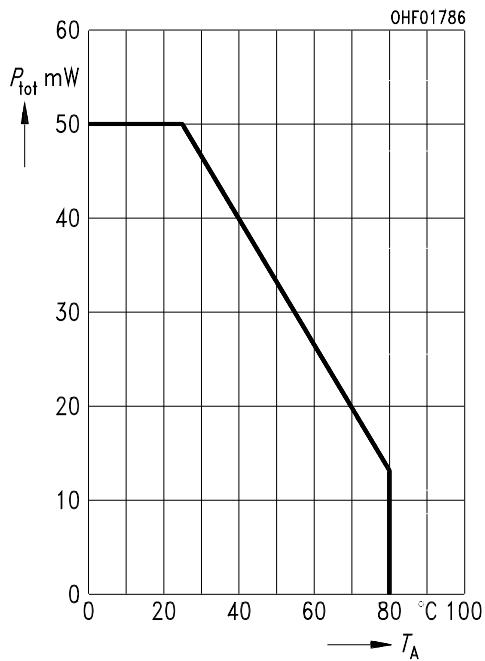
Photocurrent / Open-Circuit Voltage ^{1) page 7}

$$I_P (V_R = 5 \text{ V}) / V_O = f(E_V)$$



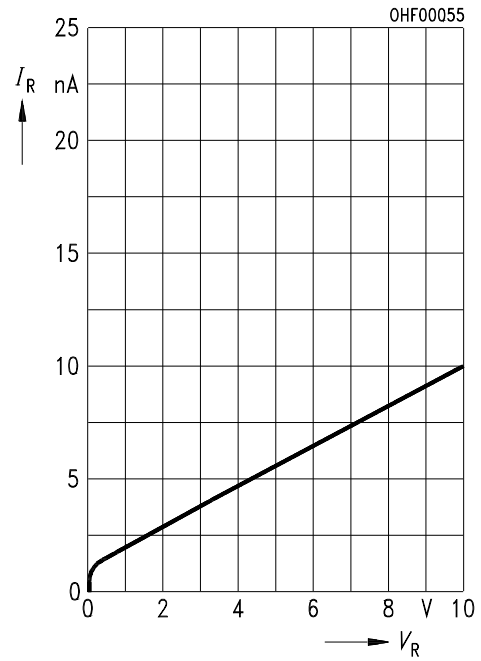
Power Consumption

$P_{tot} = f(T_A)$



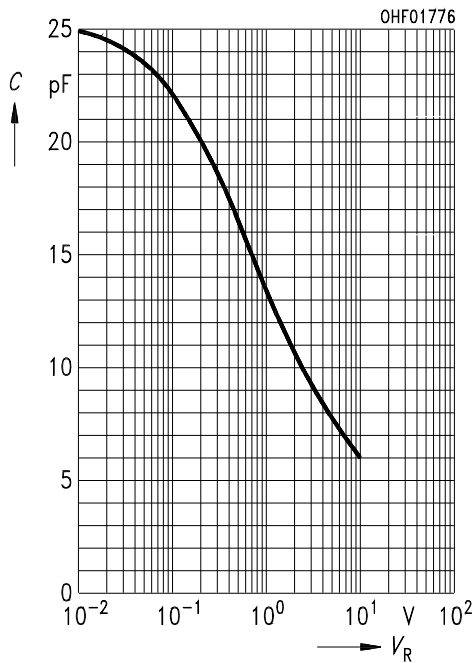
Dark Current ^{1) page 7}

$I_R = f(V_R), E = 0$



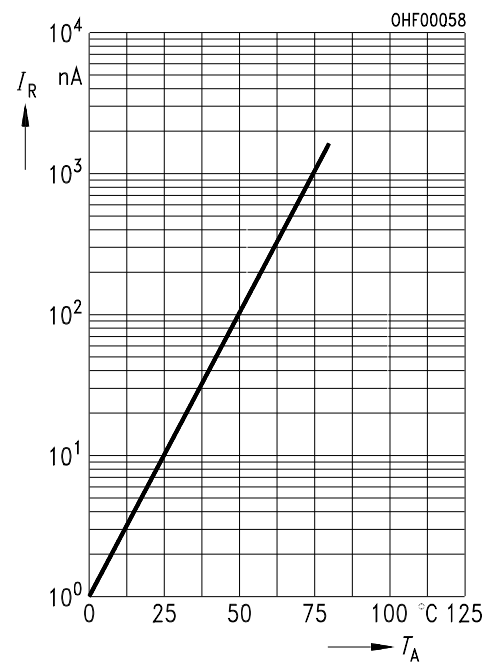
Capacitance ^{1) page 7}

$C = f(V_R), f = 1 \text{ MHz}, E = 0$



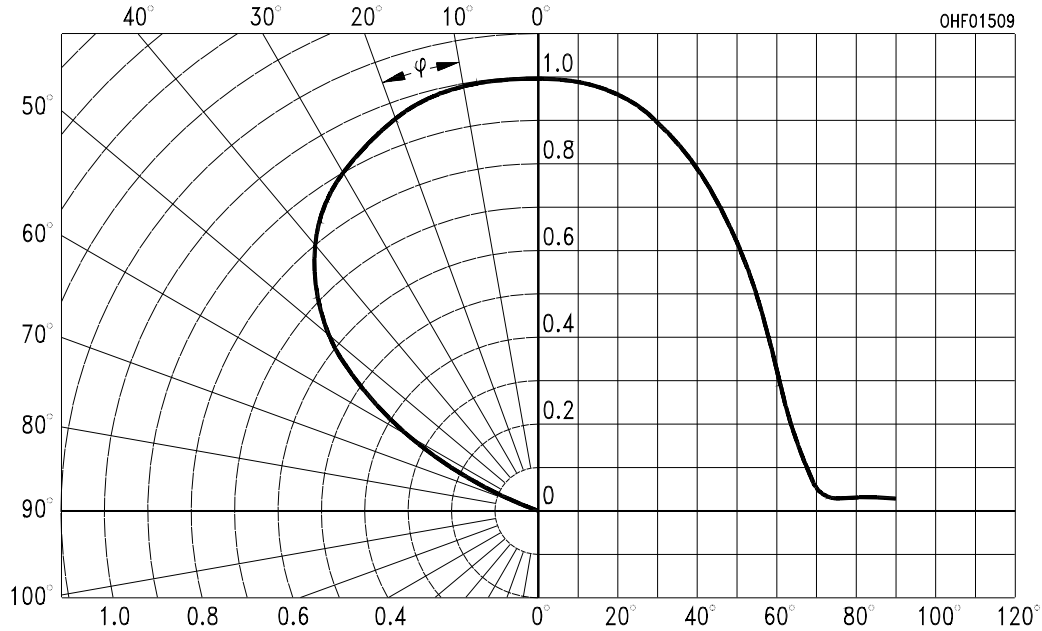
Dark Current ^{1) page 7}

$I_R = f(T_A), V_R = 10 \text{ V}, E = 0$

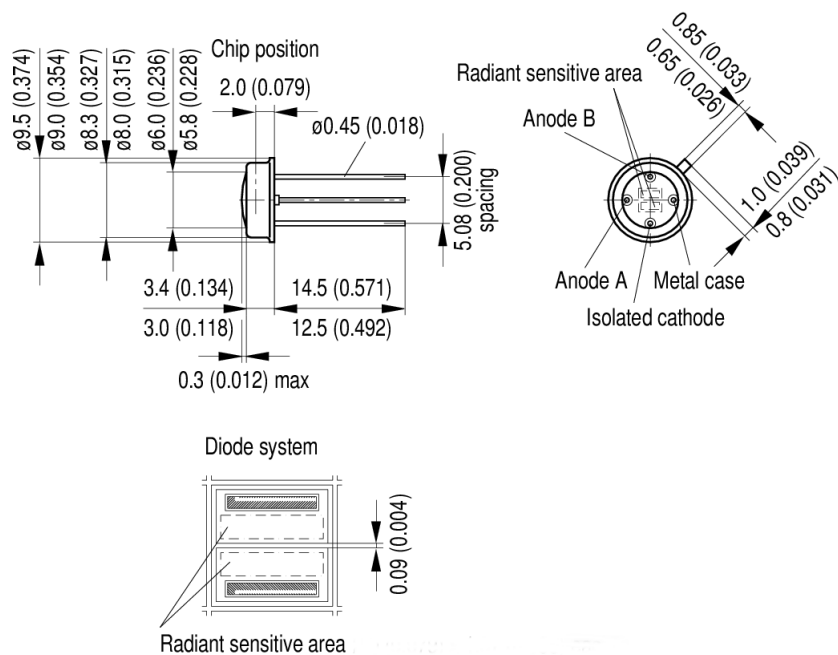


Directional Characteristics ^{1) page 7}

$S_{rel} = f(\phi)$



Package Outline



GMOY6639

Dimensions in mm (inch).

Package

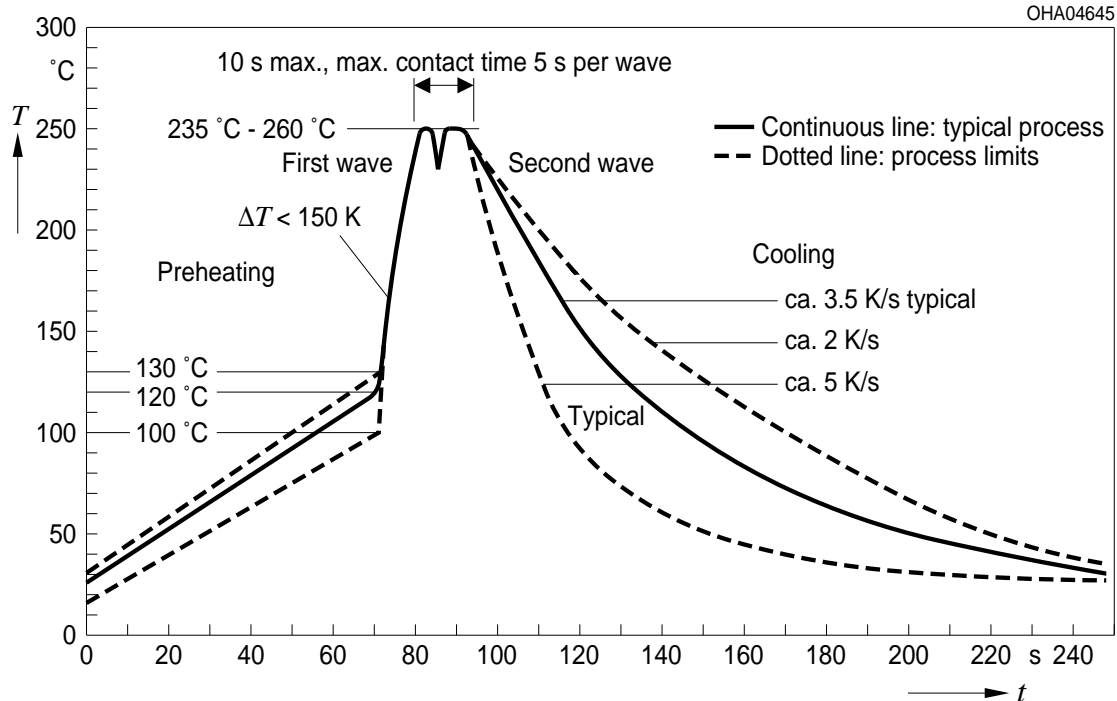
Metal Can (TO-39), hermetically sealed

Approximate Weight:

0.8 g

TTW Soldering

IEC-61760-1 TTW

**Disclaimer**

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the Internet.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components* may only be used in life-support devices** or systems with the express written approval of OSRAM OS.

*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

**) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

Glossary

- ¹⁾ **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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